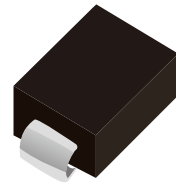
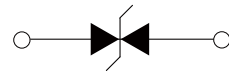


FEATURES

- | Low profile package
- | Ideal for automated placement
- | 3000 Watt peak pulse power capability with a 10/1000 μ s waveform
- | For surface mounted applications to optimize board space
- | Excellent clamping capability
- | Very fast response time
- | Low incremental surge resistance



DO-214AA(SMB)



Schematic Symbol

APPLICATIONS

- | Power supply protection
- | Automotive application
- | Industrial application
- | Power management

APPROVALS

RoHS	Compliance with 2011/65/EU
HF	Compliance with IEC61249-2-21:2003

MAXIMUM RATINGS ($T_A=25^{\circ}\text{C}$)

Parameter	Symbol	Value	Unit
Peak Pulse Power Dissipation on 10/1000 μ s waveform ^(1,2)	P_{PP}	3000	W
Peak Pulse current with a 10/1000 μ s waveform ⁽¹⁾	I_{PP}	123	A
Power Dissipation on infinite heatsink at $T_L=75^{\circ}\text{C}$	P_D	6.5	W
Peak Forward Surge Current, 8.3ms Single Half Sine-Wave Unidirectional only ⁽³⁾	I_{FSM}	200	A
Maximum instantaneous forward voltage at 100A for Unidirectional only	V_F	7.0	V

Notes : 1.Non-repetitive current pulse, $T_A=25^{\circ}\text{C}$.

2.Mounted on 5.0mm*5.0mm (0.03mm thick) Copper Pads to each terminal.

3.Measured on 8.3 ms single half sine-wave or equivalent square wave, duty cycle = 4 pulses per minute maximum;

THERMAL CONSIDERATIONS

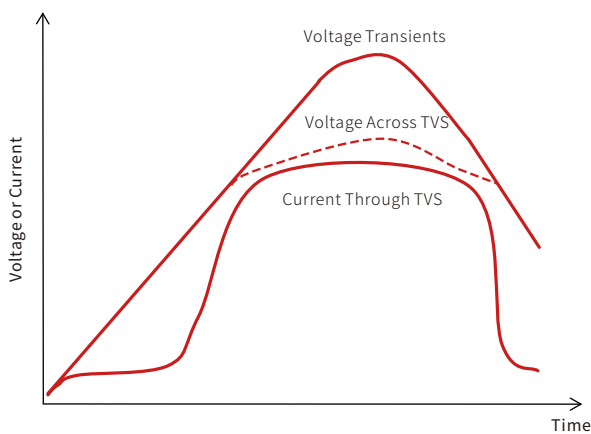
Parameter	Symbol	Value	Unit
Operating Junction Temperature	T_J	-55 to +150	$^{\circ}\text{C}$
Storage Temperature Range	T_{STG}	-55 to +150	$^{\circ}\text{C}$
Junction to Ambient on printed circuit	$R_{\theta JA}$	90	$^{\circ}\text{C/W}$

ELECTRICAL CHARACTERISTICS ($T_A=25^\circ\text{C}$)

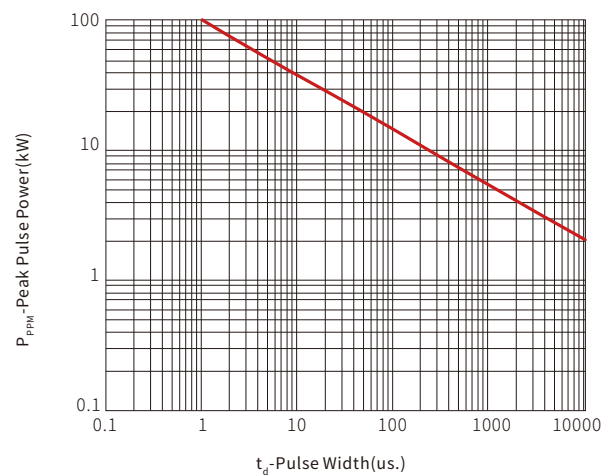
Part Number	Device Marking Code	Reverse Stand-off Voltage	Breakdown Voltage Min.@ I_T	Breakdown Voltage Max.@ I_T	Test Current	Maximum Clamping Voltage @ I_{PP}	Peak Pulse Current	Reverse Leakage @ V_{RWM}
		V_{RWM} (V)	V_{BR} (V)	V_{BR} (V)	I_T (mA)	V_C (V)	I_{PP} (A)	I_R (μ A)
SVB300B26	DFE	26.0	28.9	31.9	1.0	42.1	71.3	5.0

CHARACTERISTIC CURVES

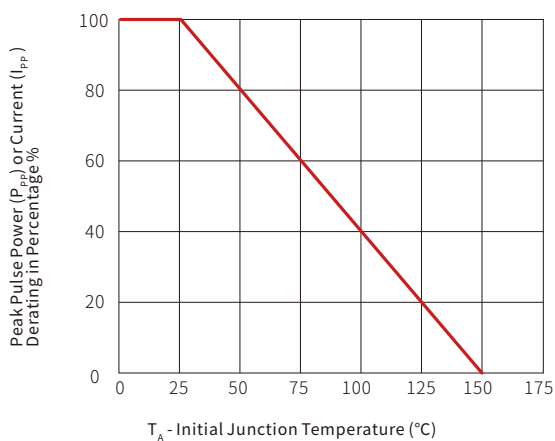
TVS Transients Clamping Waveform



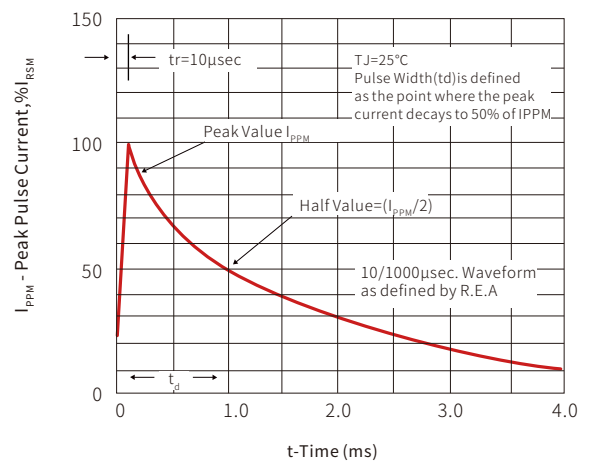
Peak Pulse Power Rating Curve



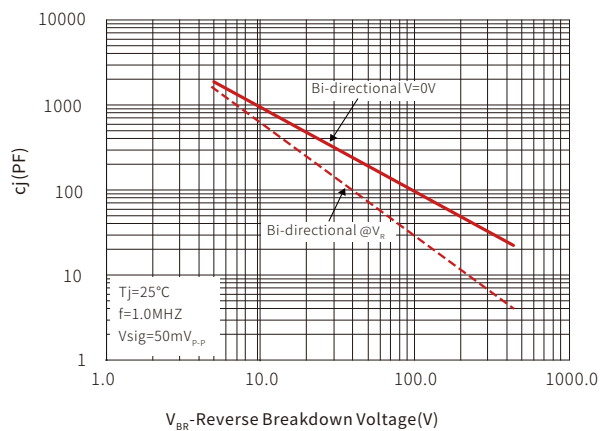
Pulse Derating Curve



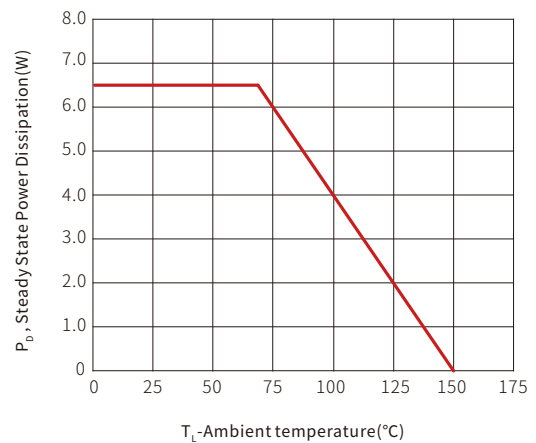
Pulse Waveform



Typical Junction Capacitance

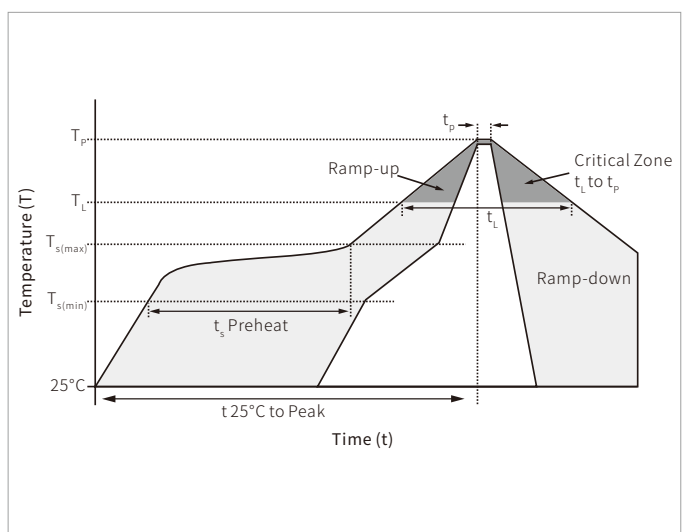


Steady State Power Dissipation Derating Curve

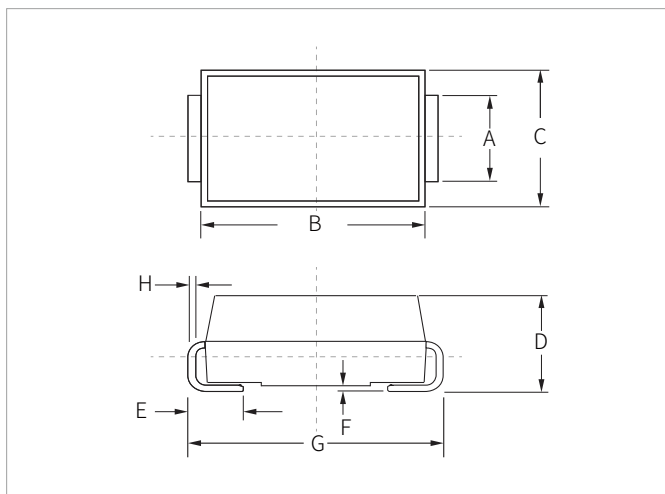


SOLDERING PARAMETERS

Reflow Condition		Lead-free assembly
Pre Heat	Temperature Max ($T_{s(min)}$)	150 $^\circ C$
	Temperature Max ($T_{s(max)}$)	200 $^\circ C$
	Time (min to max) (t_s)	60 – 180 secs
Average ramp up rate (Liquidus Temp (T_L) to peak)		3 $^\circ C$ /second max
$T_{s(max)}$ to T_L - Ramp-up Rate		3 $^\circ C$ /second max
Reflow	Temperature (T_L) (Liquidus)	217 $^\circ C$
	Time (min to max) (t_l)	60 – 150 seconds
Peak Temperature (T_p)		260 $^\circ C$
Time within 5 $^\circ C$ of actual peak Temperature (t_p)		20 – 40 seconds
Ramp-down Rate		6 $^\circ C$ /second max
Time 25 $^\circ C$ to peak Temperature (T_p)		8 minutes max.
Do not exceed		260 $^\circ C$

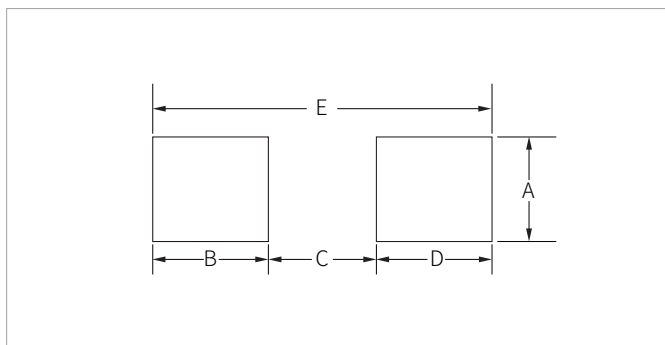


PACKAGE INFORMATION



Ref.	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	1.80	2.20	0.071	0.087
B	4.30	4.70	0.170	0.185
C	3.40	3.90	0.134	0.153
D	2.15	2.75	0.085	0.108
E	1.00	1.50	0.039	0.059
F	0.02	0.20	0.001	0.008
G	5.10	5.50	0.200	0.216
H	0.15	0.30	0.006	0.012

RECOMMENDED PAD LAYOUT DIMENSIONS



Ref.	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	2.20	-	0.087	-
B	1.45	-	0.057	-
C	-	2.55	-	0.010
D	1.45	-	0.057	-
E	5.60REF		0.220REF	

ORDERING INFORMATION

Part Number	Component Package	QTY/Reel	Reel Size
SVC300B26	DO-214AA(SMB)	3000PCS	13"

Headquarters

No.3387 Shendu Road
Pujiang I&E Park
Minhang Shanghai China
201000

Hotline

400-021-5756

Web

<https://www.semiware.com>

Sales Center

Tel: 86-21-3463-7458
Email: sales18@semiware.com

Customer Service

Tel: 86-21-5484-1001
Email: sales17@semiware.com

Technical Support

Tel: 86-21-3463-7654
Email: fae01@semiware.com

Complaint & Suggestions

Tel: 86-21-3463-7172
Ext: 8868
Email: cs03@semiware.com

By QR Code

Website



Wechat

To find your local partner within Semiware' s global website: www.semiware.com

© 2022 Semiware Semiconductor Inc.

The content of this document has been carefully checked and understood. However, neither Semiware nor its subsidiaries assume any liability whatsoever for any errors or inaccuracies of this document and the consequences thereof. Published specifications are subject to change without notice. Product suitability for any area of application must ultimately be determined by the customer. In all cases, products must never be operated outside their published specifications. Semiware does not guarantee the availability of all published products. This disclaimer shall be governed by substantive Chinese law and resulting disputes shall be settled by the courts at the place of business of Semiware. Latest publications and a complete disclaimer can be downloaded from the Semiware website. All trademarks recognized.